



RE933

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for 10 different TSSOP's
- Pitch: 0.65 mm & 0.50 mm
- Hole diameter 1.00 mm
- Pre-scratched rated break point for the separation of individual modules from the board
- Size 58.90 x 120.10 mm

Module-No.	Pitch	mil	Pin	Size (mm)
RE933-01	0.650 mm	22.5	8	4.400 (173 mil)
RE933-02	0.650 mm	22.5	14	4.400 (173 mil)
RE933-03	0.650 mm	22.5	16	4.400 (173 mil)
RE933-04	0.650 mm	22.5	20	4.400 (173 mil)
RE933-05	0.650 mm	22.5	24	4.400 (173 mil)
RE933-06	0.650 mm	22.5	28	4.400 (173 mil)
RE933-07	0.650 mm	22.5	32	4.400 (173 mil)
RE933-08	0.500 mm	19.6	38	6.100 (240 mil)
RE933-09	0.500 mm	19.6	48	6.100 (240 mil)
RE933-10	0.500 mm	19.6	56	6.100 (240 mil)